PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data		
1.1 Company STMicroelectronics International N.V		STMicroelectronics International N.V
1.2 PCN No.		MDG/19/10986
1.3 Title of PCN		ST Shenzhen (China) TSSOP 20 package Back-End line – additional products
1.4 Product Category		STM8L10, STM8L15, STM32F04 Products in TSSOP20 package.
1.5 Issue date		2019-06-28

2. PCN Team			
2.1 Contact supplier	2.1 Contact supplier		
2.1.1 Name	MARCELI SMIALKOWSKI		
2.1.2 Phone	+44 1628896277		
2.1.3 Email	marceli.smialkowski@st.com		
2.2 Change responsibility			
2.2.1 Product Manager	Ricardo Antonio DE SA EARP		
2.1.2 Marketing Manager	Veronique BARLATIER		
2.1.3 Quality Manager	Pascal NARCHE		

3. Change		
3.1 Category	3.2 Type of change	3.3 Manufacturing Location
	Any change on substrate (part number, supplier, plant, design or composition of any layer, etc)	ST Shenzhen China

4. Description of change			
	Old	New	
4.1 Description	n Back-end sources: - Amkor ATP Philippines Back-end sources: - Amkor ATP Philippines - ST Shenzhen China added		
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	 Lead color and surface finish change depending on lead finishing. Package darkness changes depending on molding compound. Pin1 identifier might change in terms of form and positioning. Marking position and size could be different upon assembly site, without any loss of information. 		

5. Reason / motivation for change		
5.1 Motivation Today, production is only made in AMKOR ATP (Philippines). In order to ensure top class service for our customers, given the continued growth of t STM32 & STM8 families, ST Microcontrollers Division will increase production capacity improve flexibility through the gualification of an additional assembly source.		
5.2 Customer Benefit	CAPACITY INCREASE	

6. Marking of parts / traceability of change		
6.1 Description Country of origin marked on package top side is changing from PHL to CHN.		

7. Timing / schedule		
7.1 Date of qualification results	2018-06-28	
7.2 Intended start of delivery	2019-07-26	
7.3 Qualification sample available?	Upon Request	

8. Qualification / Validation			
8.1 Description 10986 MDG-MCD RER1512 STM8S-STM32 TSSOP20 - ST SHZ-PCN9299- reliability evaluation report V2.0.pdf			
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2019-06-28

9. Attachments (additional documentations)

10986 Public product.pdf 10986 MDG-MCD RER1512 STM8S-STM32 TSSOP20 - ST SHZ-PCN9299- reliability evaluation report V2.0.pdf 10986 PCN10986_Additional information.final.pdf

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
0.1.1 Customer Part No 10.1.2 Supplier Part No		10.1.2 Supplier Part No
	STM8L051F3P6	
	STM8L151F3P6	
	STM32F042F4P6	

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Public Products List

Publict Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

PCN Title : ST Shenzhen (China) TSSOP 20 package Back-End line – additional products *PCN Reference :* MDG/19/10986

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

STM32F070F6P6TR	STM8L101F3P6	STM32F042F4P6TR
STM8L051F3P6TR	STM8L151F3P3	STM8L101F2P3TR
STM8L151F3P6TR	STM32F042F6P7	STM8L101F2P3
STM8L051F3P6	STM8L101F2P6	STM8L151F2P6TR
STM8L151F2P6	STM8L151F3P6	STM32F070F6P6
STM8L101F2P6TR	STM8L101F3P6TR	STM32F042F4P6
STM32F042F6P6	STM8L101F3P3	

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